- Operating Range 2-V to 5.5-V V_{CC}
- EPIC[™] (Enhanced-Performance Implanted CMOS) Process
- Designed Specifically for High-Speed Memory Decoders and Data Transmission Systems
- Incorporate Two Enable Inputs to Simplify Cascading and/or Data Reception
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

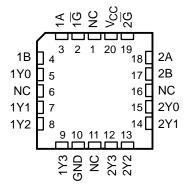
description

The 'AHC139 are dual 2-line to 4-line decoders/ demultiplexers designed for 2-V to 5.5-V V_{CC} operation. These devices are designed to be used in high-performance memory-decoding or datarouting applications requiring very short propagation delay times. In high-performance memory systems, these decoders can be used to minimize the effects of system decoding. When used with high-speed memories utilizing a fast enable circuit, the delay times of these decoders and the enable time of the memory are usually less than the typical access time of the memory. This means that the effective system delay introduced by the decoders is negligible. SN54AHC139...J OR W PACKAGE

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SN74AHC139 D, DB, N, OR PW PACKAGE (TOP VIEW)								
1G [1A [1B [1Y0 [1Y1 [1Y2 [1Y3 [GND [1 2 3 4 5 6 7 8	14 13 12 11 10	V _{CC} 2G 2A 2B 2Y0 2Y1 2Y2 2Y3					

SN54AHC139 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The active-low enable (\overline{G}) input can be used as a data line in demultiplexing applications. These decoders/demultiplexers feature fully buffered inputs, each of which represents only one normalized load to its driving circuit.

The SN54AHC139 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74AHC139 is characterized for operation from -40° C to 85° C.

	INPUTS		OUTPUTS							
G	SEL	ECT	0012013							
G	В	Α	Y0	Y1	Y2	Y3				
Н	Х	Х	Н	Н	Н	Н				
L	L	L	L	Н	Н	н				
L	L	н	н	L	Н	н				
L	н	L	н	Н	L	Н				
L	н	Н	н	н	н	L				

FUNCTION TABLE



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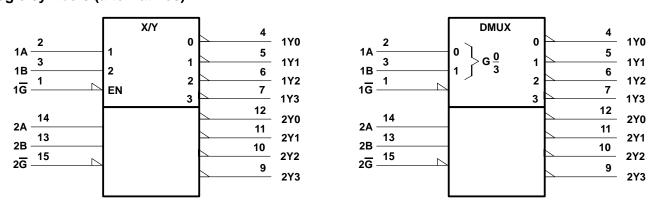
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PRODUCT PREVIEW

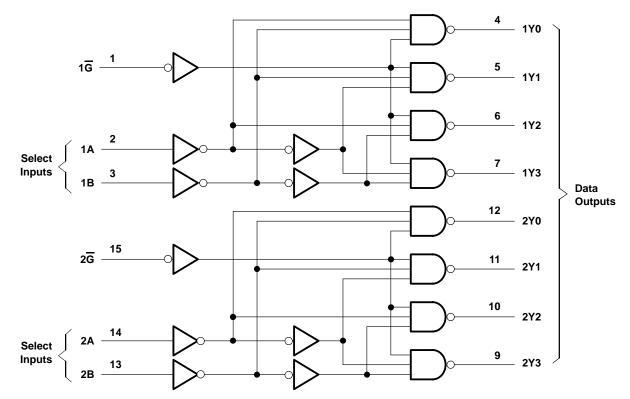
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logic symbols (alternatives)[†]



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, J, N, PW, and W packages.

logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, N, PW, and W packages.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_I (see Note 1) Output voltage range, V_O (see Note 1) Input clamp current, I_{IK} ($V_I < 0$) Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) Continuous output current, I_O ($V_O = 0$ to V_{CC}) Continuous current through V_{CC} or GND Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2)	-0.5 V to 7 V -0.5 V to V _{CC} + 0.5 V -20 mA ±20 mA ±25 mA ±75 mA): D package
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.

recommended operating conditions (see Note 3)

			SN54A	HC139	SN74A	HC139	UNIT	
			MIN	MAX	MIN	MAX		
VCC	Supply voltage		2	5.5	2	5.5	V	
		V _{CC} = 2 V	1.5		1.5			
VIH	High-level input voltage	V _{CC} = 3 V	2.1		2.1		V	
		V _{CC} = 5.5 V	3.85		3.85			
		$V_{CC} = 2 V$		0.5		0.5		
VIL	Low-level input voltage	V _{CC} = 3 V		0.9		0.9	V	
		V _{CC} = 5.5 V		1.65		1.65		
VI	Input voltage		0	5.5	0	5.5	V	
VO	Output voltage		0	VCC	0	VCC	V	
		V _{CC} = 2 V		-50		-50	μA	
IОН	High-level output current	V_{CC} = 3.3 V ± 0.3 V		-4		-4	~^^	
		V_{CC} = 5 V ± 0.5 V		-8		-8	mA	
		$V_{CC} = 2 V$		50		50	μΑ	
IOL	Low-level output current	V_{CC} = 3.3 V ± 0.3 V		4		4	mA	
		V_{CC} = 5 V ± 0.5 V		8		8	mA	
A+/A.	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100		100	n n//	
$\Delta t / \Delta v$	Input transition rise or fall rate	V_{CC} = 5 V ± 0.5 V		20		20	ns/V	
TA	Operating free-air temperature		-55	125	-40	85	°C	

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	N	Т	→ = 25°C	;	SN54AHC139		SN74AHC139		
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		2 V	1.9	2		1.9		1.9		
	I _{OH} = -50 μA	3 V	2.9	3		2.9		2.9		
VOH		4.5 V	4.4	4.5		4.4		4.4		V
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		2.48		
	I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8		
	I _{OL} = 50 μA	2 V			0.1		0.1		0.1	
		3 V			0.1		0.1		0.1	
VOL		4.5 V			0.1		0.1		0.1	V
	I _{OL} = 4 mA	3 V			0.36		0.5		0.44	
	I _{OL} = 8 mA	4.5 V			0.36		0.5		0.44	
Ц	$V_{I} = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ
ICC	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	5.5 V			4		40		40	μΑ
Ci	V _I = V _{CC} or GND	5 V		4	10				10	pF

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

					SN	54AHC1	39				
PARAMETER	FROM (INPUT)	TO (OUTPUT)	OUTPUT CAPACITANCE	T _A = 25°C			MIN	MAX	UNIT		
		(001101)	OAI AONANGE	MIN	TYP	MAX		WAA			
^t PLH [*]	A or B	v	C _L = 15 pF		7.2	11	1	13	ns		
^t PHL [*]	AUB	I	0 <u>[</u> = 15 pr		7.2	11	1	13	115		
^t PLH [*]	G	V	Y C _L = 15 pF		6.4	9.2	1	11	ns		
^t PHL*	G	I			6.4	9.2	1	11	115		
^t PLH	A or B	Y	$C_{\rm L} = 50 \rm pE$		9.7	14.5	1	16.5	ns		
^t PHL	AUIB	T	C _L = 50 pF		9.7	14.5	1	16.5	115		
^t PLH	G	Y	$C_{\rm L} = 50 \rm pE$		8.9	12.7	1	14.5	ns		
^t PHL		Y	Y	Ŷ	Y $C_{L} = 50 \text{ pF}$		8.9	12.7	1	14.5	115

* On products compliant to MIL-PRF-38535, this parameter is ensured but not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

				SN74AHC139									
PARAMETER	FROM (INPUT)	TO (OUTPUT)	OUTPUT CAPACITANCE	Т	4 = 25°C	;	MIN	МАХ	UNIT				
	((,		MIN	TYP	MAX	IVIIIN	WAA					
^t PLH	A or B	Y	C _L = 15 pF		7.2	11	1	13					
^t PHL	AUB	T			7.2	11	1	13	ns				
^t PLH	G	Y			6.4	9.2	1	11	ns				
^t PHL	G		I		Y C _L = 15 pF		6.4	9.2	1	11	115		
^t PLH	A or B	Y			9.7	14.5	1	16.5					
^t PHL	AUIB			C _L = 50 pF	CL = 50 pr	CL = 30 pr	9.7	14.5	1	16.5	ns		
^t PLH	G	Y	$C_{1} = 50 \text{ pE}$		8.9	12.7	1	14.5					
^t PHL	9	ř	Ť	T	Ť	T C	Y C _L = 50 pF		8.9	12.7	1	14.5	ns



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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

				SN54AHC139						
PARAMETER	FROM (INPUT)	TO (OUTPUT)	OUTPUT CAPACITANCE	T _A = 25°C			MIN	MAX	UNIT	
		(001101)		•••••••	MIN	TYP	MAX	IVIIIN	MAX	
^t PLH [*]	A or B	Y	C _L = 15 pF		5	7.2	1	8.5	ns	
^t PHL*	AUID	T			5	7.2	1	8.5	115	
^t PLH [*]	G	Y Ci = 15 pF	C 15 pE		4.4	6.3	1	7.5	ns	
^t PHL [*]	G		CL = 15 pF		4.4	6.3	1	7.5	115	
^t PLH	A or B	Y	C _L = 50 pF		6.5	9.2	1	10.5	ns	
^t PHL	AUB		CL = 50 pF		6.5	9.2	1	10.5	115	
^t PLH	G	Y	$C_{1} = 50 \text{ pF}$		5.9	8.3	1	9.5	ns	
^t PHL			C _L = 50 pF		5.9	8.3	1	9.5	115	

* On products compliant to MIL-PRF-38535, this parameter is ensured but not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

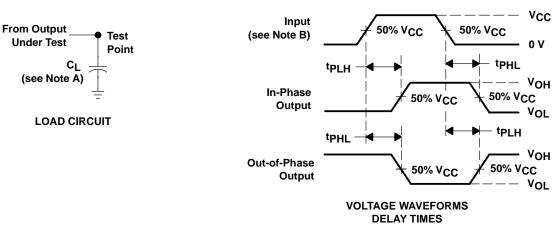
					SN	74AHC1	39			
PARAMETER	FROM (INPUT)	TO (OUTPUT)		T _A = 25°C			MIN M	МАХ	UNIT	
	((001101)	OAI AONAIOE	MIN	TYP	MAX	IVITIN	WAA		
^t PLH	A or B	Y	C _L = 15 pF		5	7.2	1	8.5	ns	
^t PHL	AUB	T			5	7.2	1	8.5		
^t PLH	IJ	Y	C _L = 15 pF	0. 45 pF		4.4	6.3	1	7.5	
^t PHL	G	T			4.4	6.3	1	7.5	ns	
^t PLH	A or B	Y	$C_{1} = 50 \text{ pE}$		6.5	9.2	1	10.5		
^t PHL	AUB	T	C _L = 50 pF		6.5	9.2	1	10.5	ns	
^t PLH	G	Y	$C_{\rm b} = 50 \rm pE$		5.9	8.3	1	9.5	ns	
^t PHL	9	ſ	C _L = 50 pF		5.9	8.3	1	9.5	115	

operating characteristics, V_{CC} = 5 V, T_A = 25° C

	PARAMETER		NDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance per gate	No load,	f = 1 MHz	26	pF



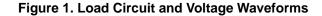
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PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 3 ns, t_f = 3 ns.
- C. The outputs are measured one at a time with one input transition per measurement.





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